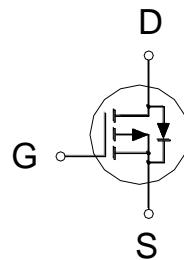


NIKO-SEM**P-Channel Logic Level Enhancement Mode
Field Effect Transistor****PK501BA
PDFN 5x6P
Halogen-Free & Lead-Free****PRODUCT SUMMARY**

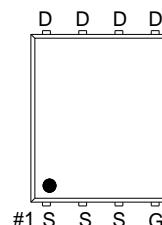
$V_{(BR)DSS}$	$R_{DS(on)}$	I_D
-30V	7mΩ	-70A

**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low $R_{DS(on)}$ to Minimize Conduction Losses.
- Ohmic Region Good $R_{DS(on)}$ Ratio.
- Optimized Gate Charge to Minimize Switching Losses.
- ESD Protected up to 2KV.

Applications

- Protection Circuits Applications.
- Logic/Load Switch Circuits Applications.



G : GATE
D : DRAIN
S : SOURCE

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 25	V
Continuous Drain Current	I_D	-70	A
		-44	
		-16	
		-13	
Pulsed Drain Current ¹	I_{DM}	-110	
Avalanche Current	I_{AS}	-38	
Avalanche Energy	E_{AS}	72	mJ
Power Dissipation	P_D	59	W
		23	
		3.2	
		2	
Operating Junction & Storage Temperature Range	T_j, T_{stg}	-55 to 150	°C

NIKO-SEM**P-Channel Logic Level Enhancement Mode
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THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ¹	t ≤ 10s			39	°C / W
	Steady-State	R _{θJA}		56	
Junction-to-Case		R _{θJC}		2.1	

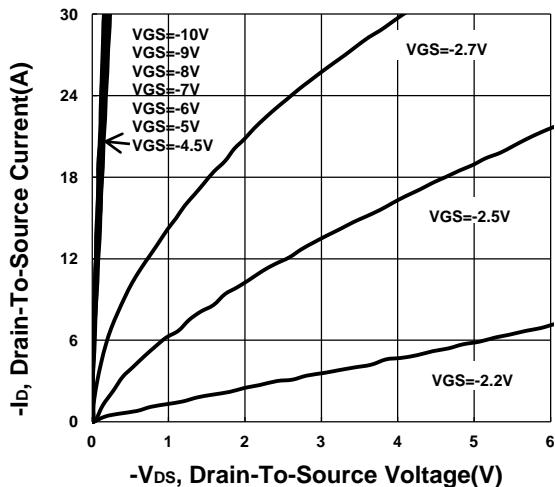
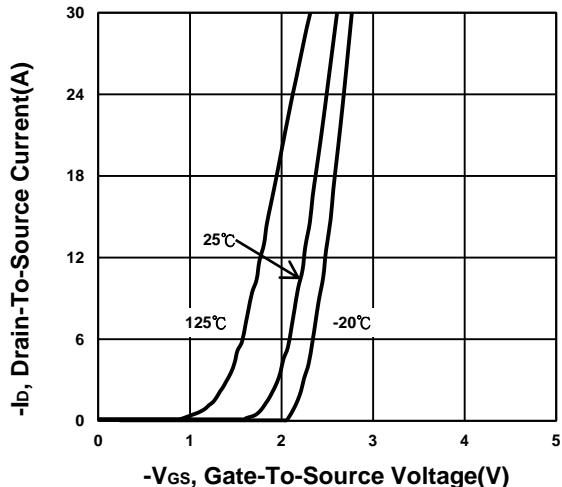
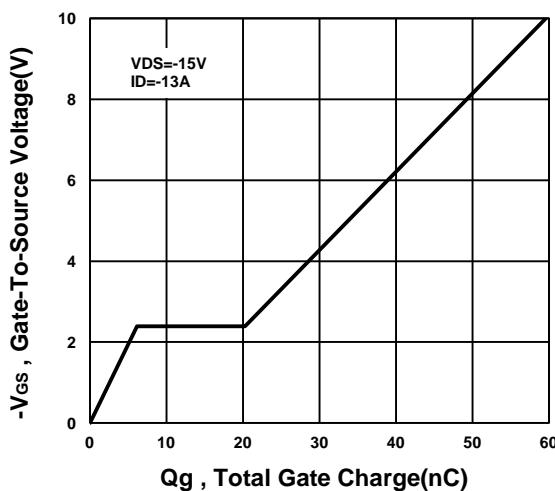
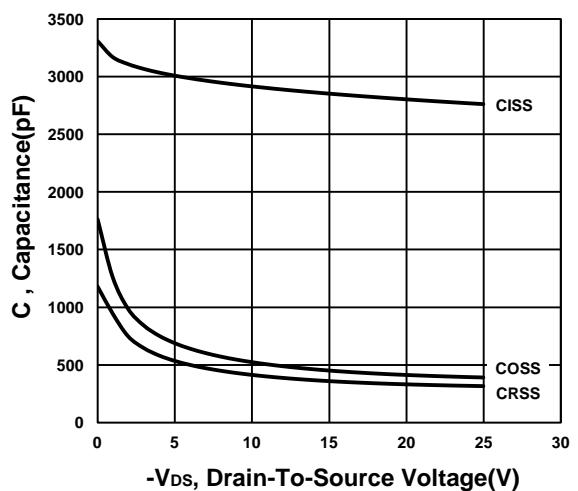
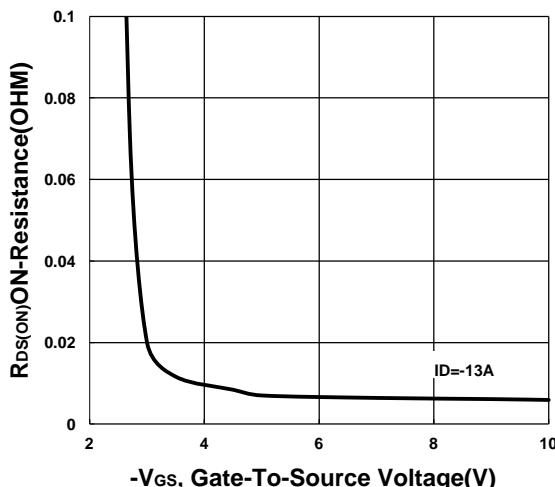
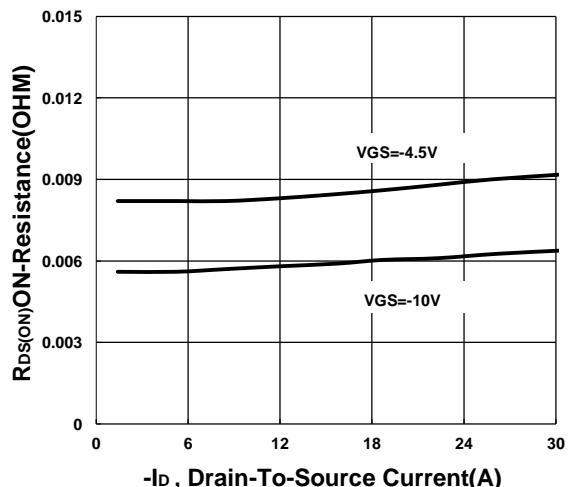
¹Pulse width limited by maximum junction temperature.²The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A = 25 °C. The value in any given application depends on the user's specific board design.**ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)**

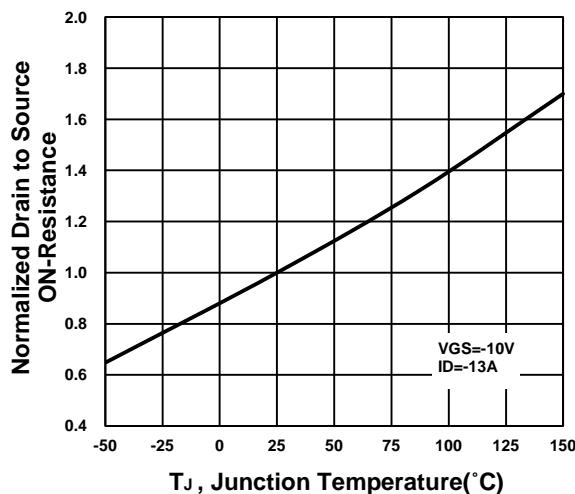
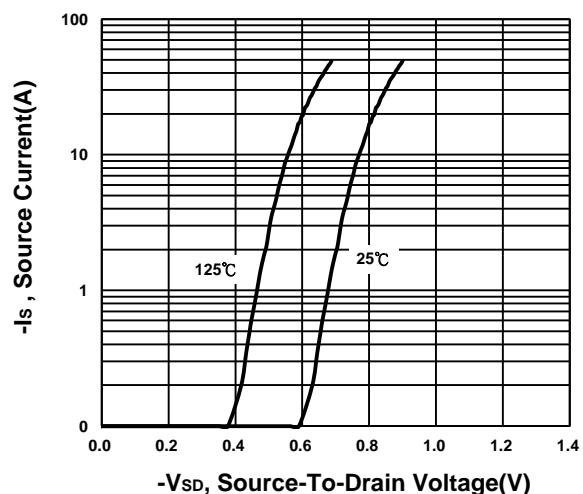
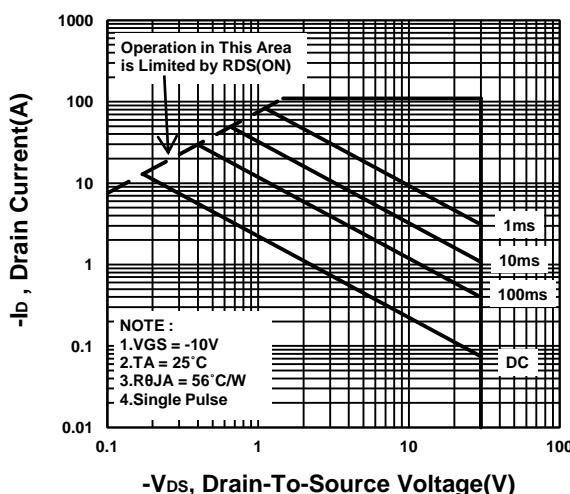
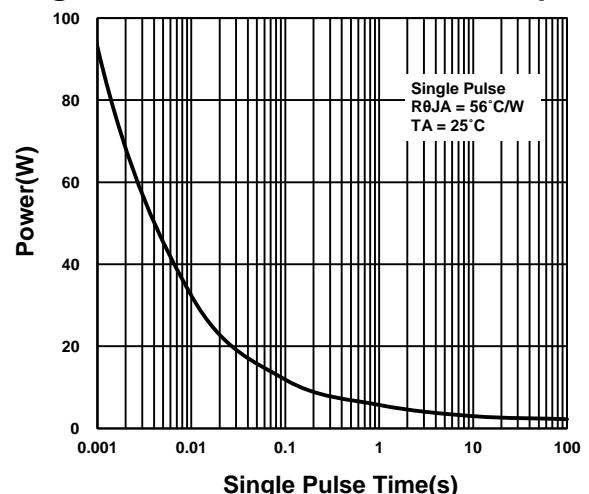
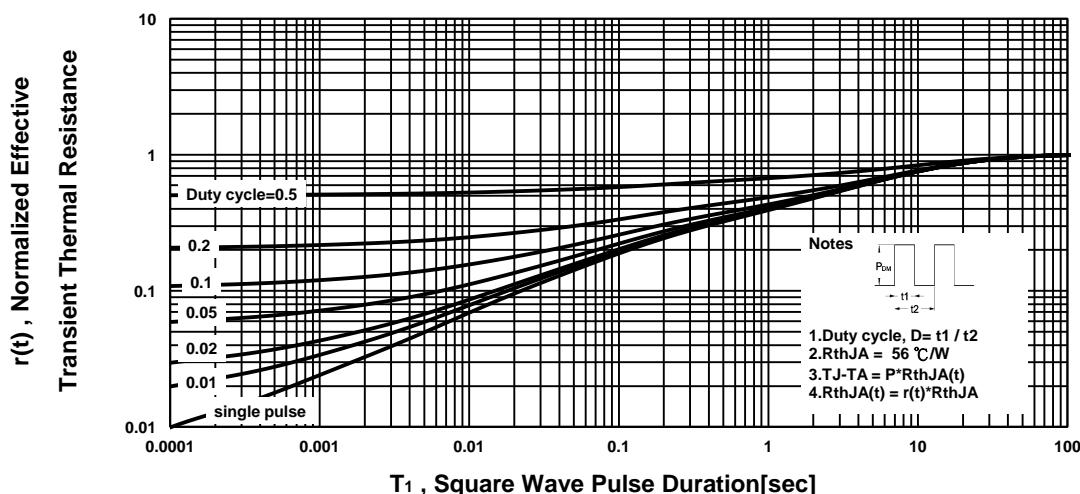
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-30			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1	-1.5	-3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±25V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -24V, V _{GS} = 0V			-1	uA
		V _{DS} = -20V, V _{GS} = 0V, T _J = 125 °C			-10	
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = -4.5V, I _D = -13A		8.4	12	mΩ
		V _{GS} = -10V, I _D = -13A		5.7	7	
Forward Transconductance ¹	g _f	V _{DS} = -5V, I _D = -13A		40		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = -15V, f = 1MHz		2822		pF
Output Capacitance	C _{oss}			452		
Reverse Transfer Capacitance	C _{rss}			364		
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		4		Ω
Total Gate Charge ²	Q _{g(VGS=-10V)}	V _{DS} = -15V, I _D = -13A		60		nC
	Q _{g(VGS=-4.5V)}			30		
Gate-Source Charge ²	Q _{gs}			6.1		
Gate-Drain Charge ²	Q _{gd}			14		
Turn-On Delay Time ²	t _{d(on)}			39		nS
Rise Time ²	t _r			26		
Turn-Off Delay Time ²	t _{d(off)}			161		
Fall Time ²	t _f			100		

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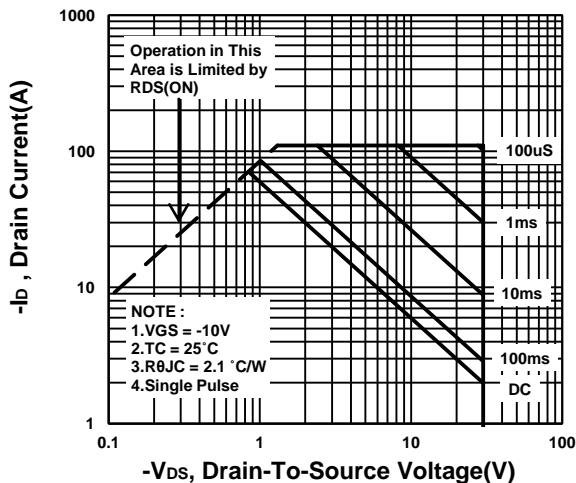
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$)						
Continuous Current	I_S				-49	A
Forward Voltage ¹	V_{SD}	$I_F = -13\text{A}$, $V_{GS} = 0\text{V}$			-1.3	V
Reverse Recovery Time	t_{rr}	$I_F = -13\text{A}$, $dI_F/dt = 100 \text{ A} / \mu\text{s}$		23		nS
Reverse Recovery Charge	Q_{rr}			6		nC

¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.²Independent of operating temperature.

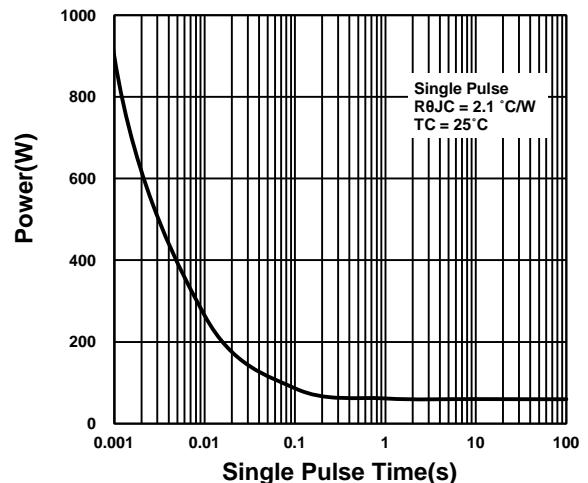
NIKO-SEM**P-Channel Logic Level Enhancement Mode
Field Effect Transistor****PK501BA
PDFN 5x6P
Halogen-Free & Lead-Free****Output Characteristics****Transfer Characteristics****Gate charge Characteristics****Capacitance Characteristic****On-Resistance VS Gate-To-Source****On-Resistance VS Drain Current**

NIKO-SEM**P-Channel Logic Level Enhancement Mode
Field Effect Transistor****PK501BA
PDFN 5x6P
Halogen-Free & Lead-Free****On-Resistance VS Temperature****Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**

Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

